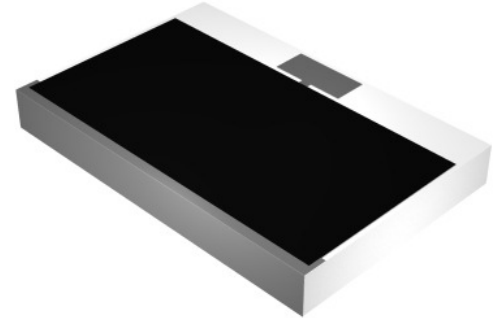


FEATURES

DC – 8.0 GHz
 100 Watt
 BeO Substrate
 Low VSWR

APPLICATIONS

Mobile Networks
 Broadcast
 High Power Amplifiers
 Instrumentation
 Isolators
 Military
 Satellite Communications



GENERAL DESCRIPTION

EMC Technology's terminations are designed for direct installation on printed circuit boards and manufactured using thick film technology. Edge metallization form the solder fillets for stronger attachment, easier inspection and increased heat removal area. The devices are available in Alumina, Aluminum Nitride or Beryllium Oxide.

SPECIFICATIONS

1.0 ELECTRICAL

Nominal Impedance: 50 Ω
 Frequency Range: DC – 8.0 GHz
 VSWR: 1.25:1 Max
 Temperature Coefficient: ± 200 PPM/ $^{\circ}\text{C}$ Max
 Power Rating: 100 Watts
 Operating Temperature: -55 $^{\circ}\text{C}$ To +125 $^{\circ}\text{C}$
 DC Resistance: 50 $\Omega \pm 2\%$

2.0 MECHANICAL

Substrate: Beryllium Oxide
 Resistive Film: Thick Film
 Metallization: Thick Film

3.0 UNIT MARKING

None

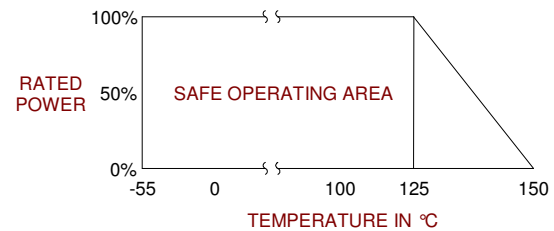
4.0 PACKAGING

Standard: Tape and Reel
 Optional: Available Upon Request

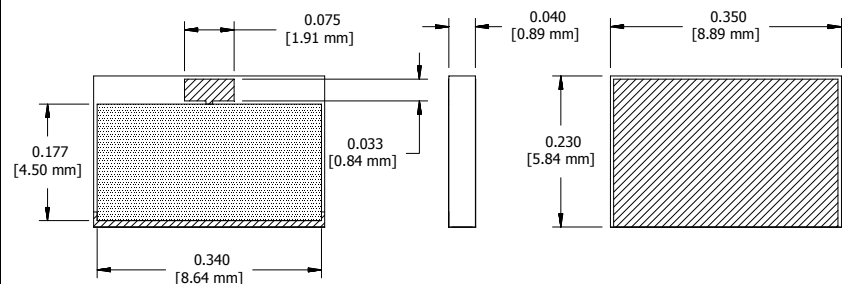
5.0 PART NUMBERING

Part Identifier: CT2335H

POWER RATING AND DERATING



MECHANICAL OUTLINE



Note: Specifications are subject to change without notice.

TOLERANCE: $\pm .010$